



EXPERIMENTAL CHARACTERIZATION OF AL – CU THERMAL CONTACT RESISTANCE BELOW 50 K

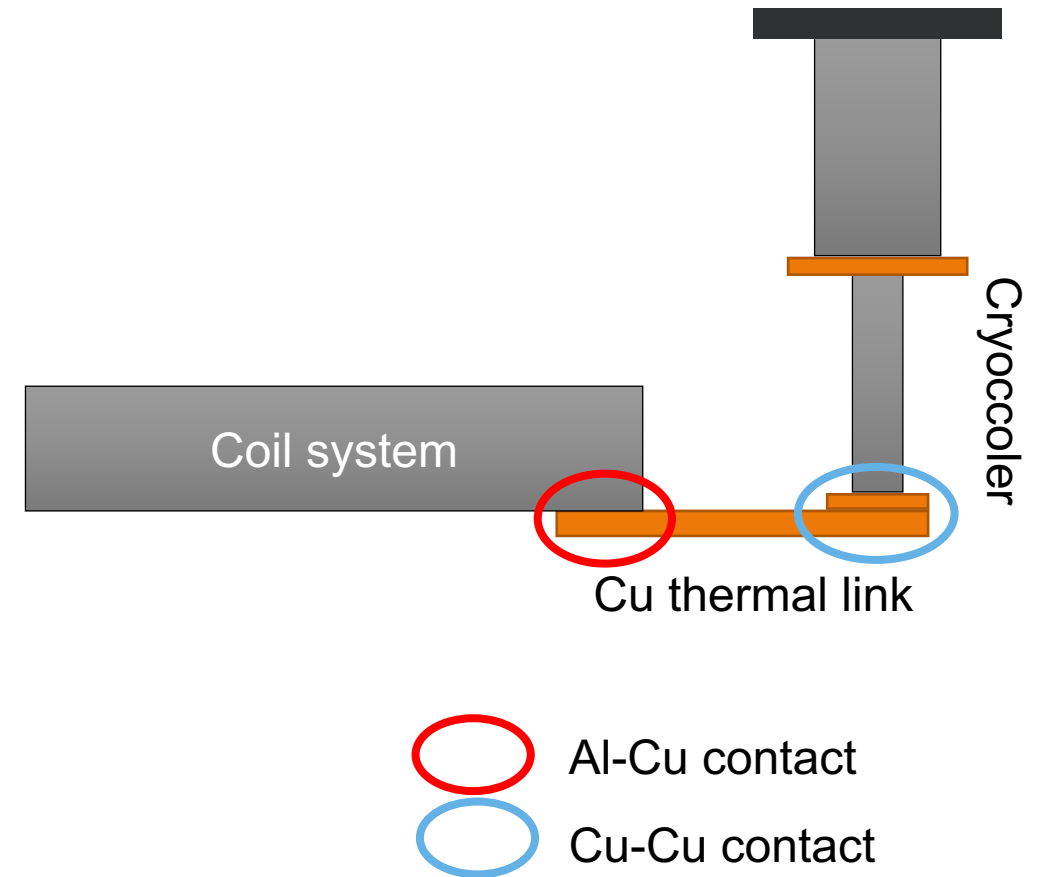
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Motivation

- Measurements done in the framework of the project “IMDS*”
 - 3 conduction-cooled NbTi superconducting coils
 - For every 100 mK increase
→ 23% decrease in current
 - Thermal contact resistance (TCR) plays a big role!

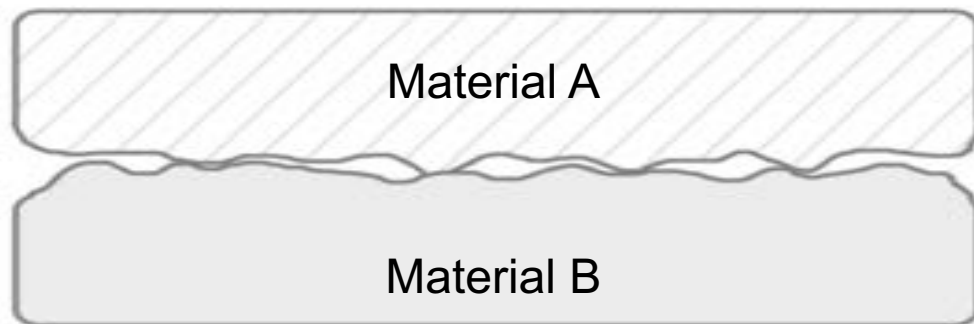


*URL: <https://www.utwente.nl/en/tnw/ems/research/sust/MDS/>

Literature on TCR of pressed metal contacts

Medium	Scales with	Best use
Dry	Force	
Grease	Area	Large areas Low pressure
Indium	Area	0.05-0.1 mm thick $P > 1 \text{ MPa}$
Gold plated	Force	High force

Jack W. Ekin, "Experimental techniques for low-temperature measurements", 2016

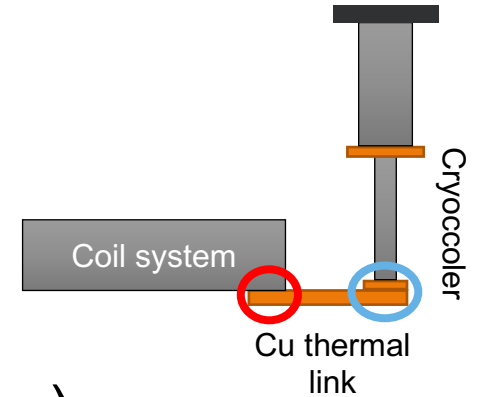


- Temperature dependence: $\text{TCR}^{-1} = \alpha T^\gamma$
- For perfect surfaces @ $T < 50 \text{ K}$:
 - $\gamma = 1 \rightarrow$ electrons
 - $\gamma = 3 \rightarrow$ phonons
- Imperfect surfaces @ $T < 50 \text{ K}$:
 - $1 < \gamma < 3$
 - γ decreases with α

E. Gmelin, et al. "Thermal boundary resistance of mechanical contacts between solids at sub-ambient temperatures", J. Phys. D: Appl. Phys. 32, 1998

Measurement campaign

- Practical approach
 - Typical cold finger size area $\approx 35 \text{ cm}^2$ ($\approx \varnothing 62 \text{ mm}$ cold finger)
 - 6 X M5 bolts – 5 N/m ≈ 2.7 tons force (calibrated at RT)



1. AI RRR 1600 – ETP Cu

2. ETP Cu – ETP Cu

a) Dry

b) Apiezon-N

c) Indium foil

d) Apiezon-N loaded with Ag powder (5-8 μm)

Measurement campaign – Where are we now?

1) Al RRR 1600 – Cu RRR 50

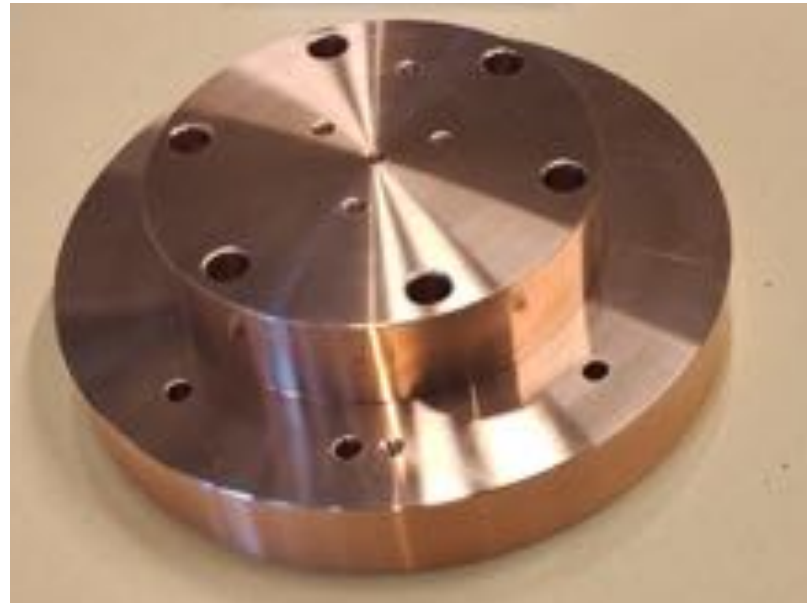
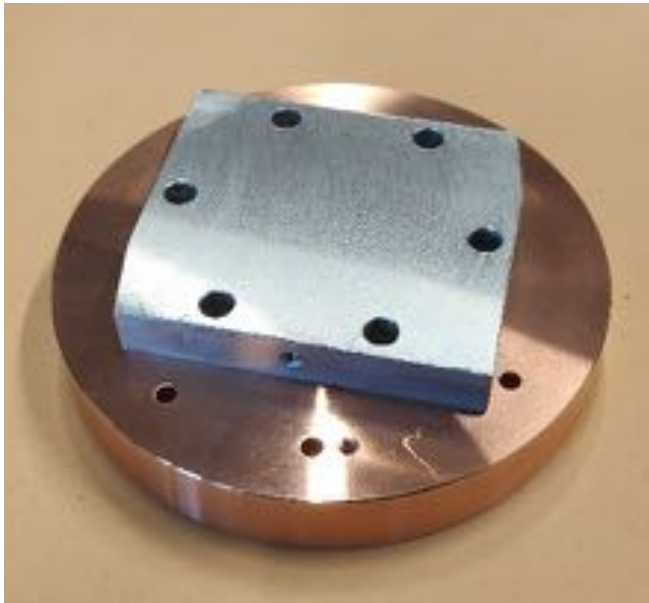
2) Cu RRR50– Cu RRR50

a) Dry

b) Apiezon-N

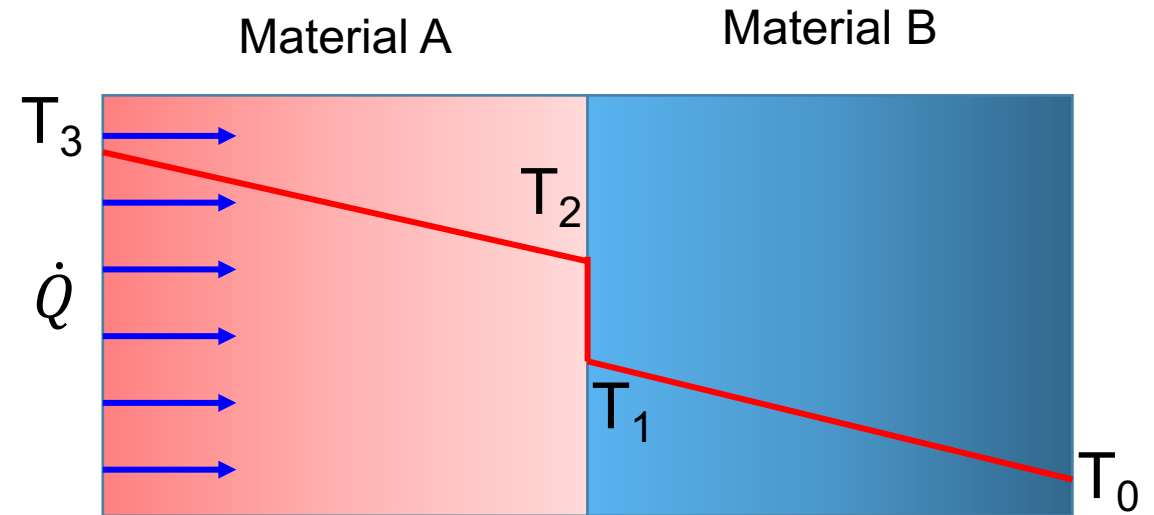
c) Indium foil

d) Apiezon-N loaded with silver powder (5-8 μm)



Thermal contact resistance — Steady state measurements

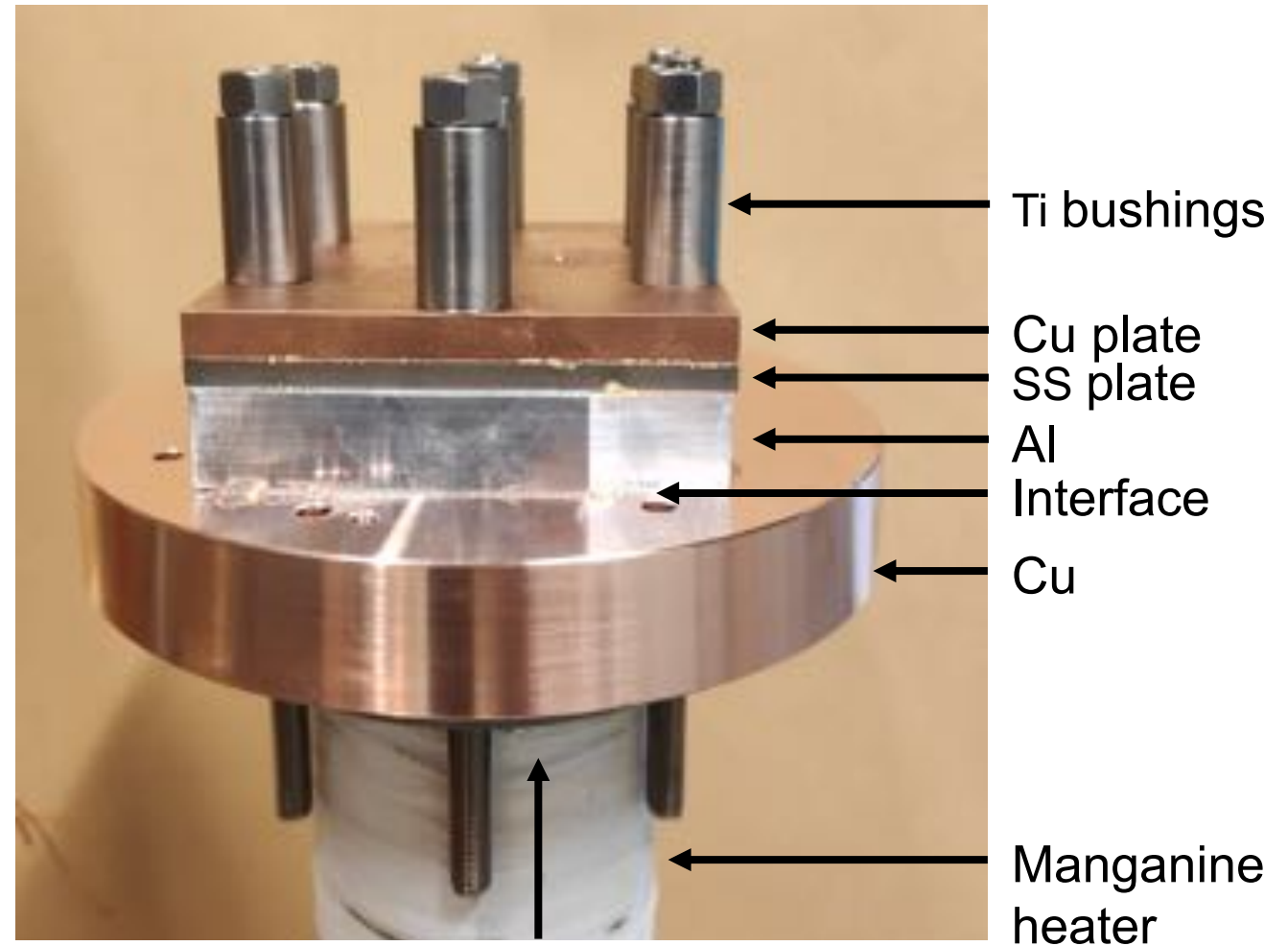
- 1) T_0 is fixed
- 2) Different loads \dot{Q} are applied
- 3) Temperatures are stabilized
- 4) T_3 and T_0 are measured
- 5) $\frac{\partial(T_2 - T_1)}{\partial \dot{Q}}$, $\Delta T \ll T \approx \text{TCR}$
- 6) For every temperature
→ 6 different \dot{Q} are applied



$$\text{TCR} = \frac{T_2 - T_1}{\dot{Q}}$$

Set-up

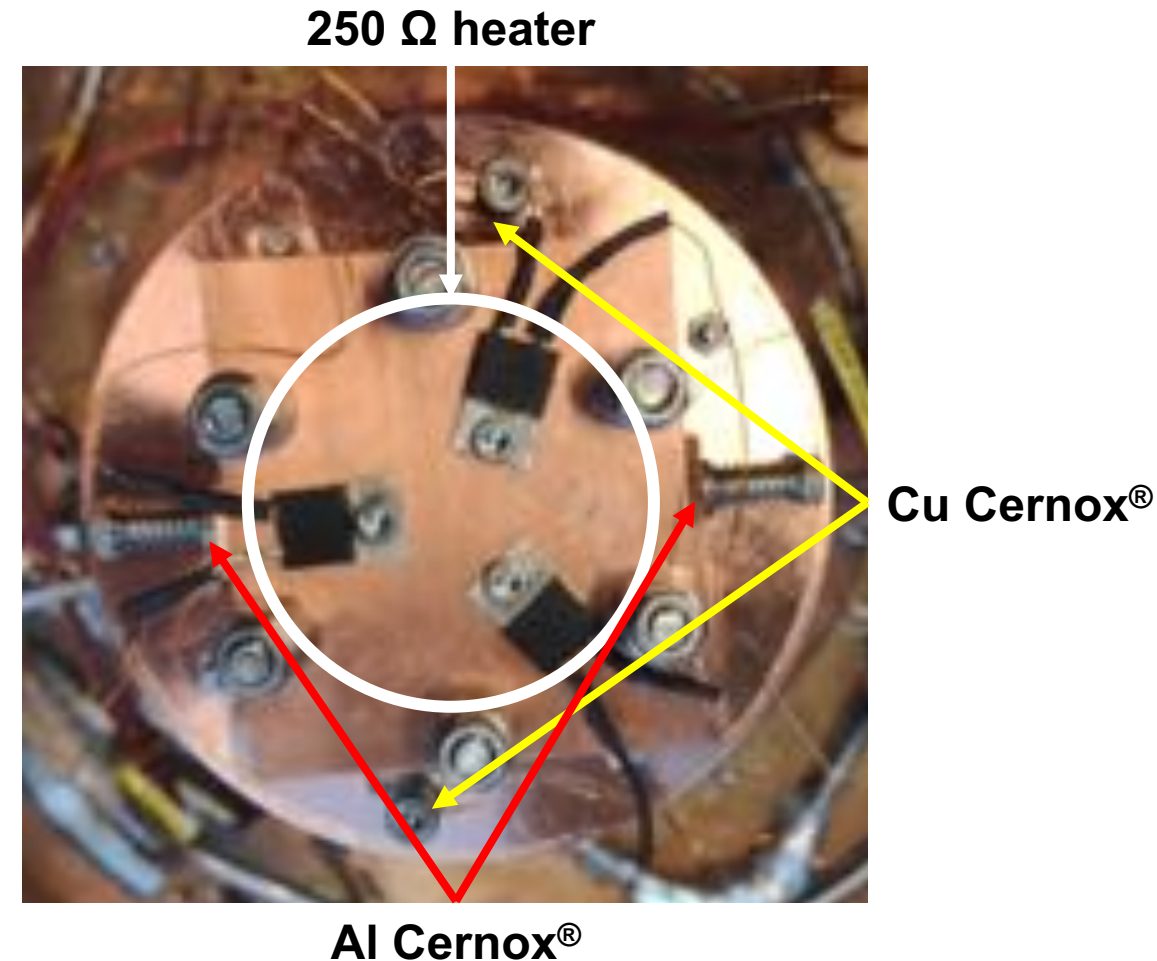
- Manganine heater
 - Controls Cu temperature
- SS plate
 - Homogenizes pressure
- Cu plate
 - Homogenizes heat flux
- Ti bushings
 - Prevents differential thermal contractions



GM cooler → 1 W @ 4.2 K

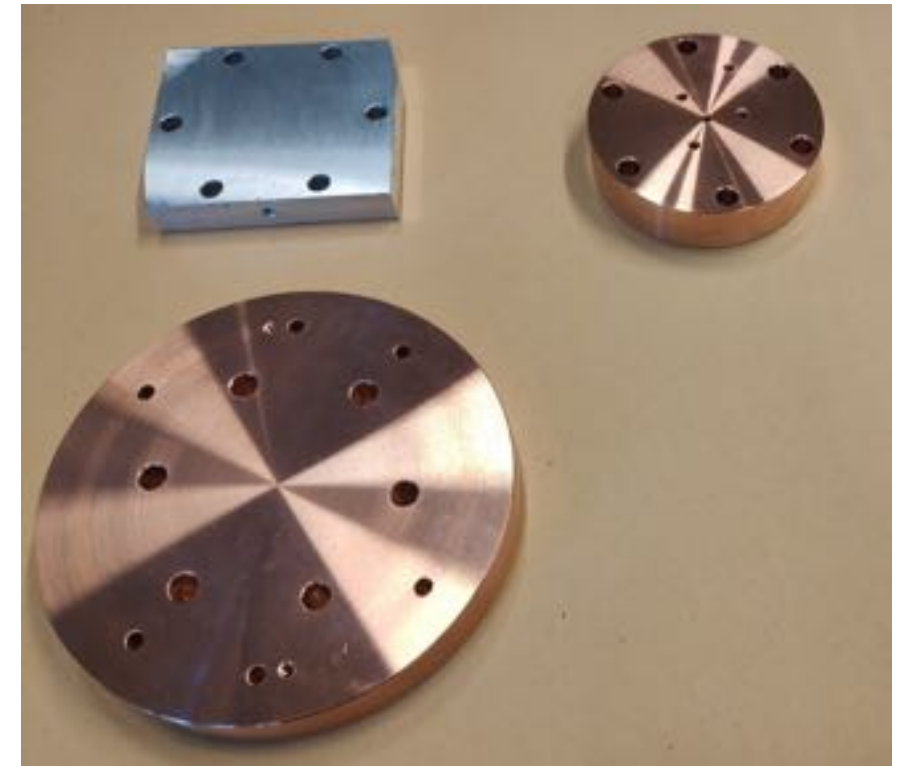
Set-up

- 250 Ω heater
 - Establishes a heat flux (max **10 W**)
 - **Heat leak** from
2 X 0.2 mm Cu wires $< 1\%$
- 4 calibrated Cernox[®] thermometers
 - 2 on the Al
 - 2 on the Cu } Redundancy
- Thermal shield
 - Radiation < 1 mW



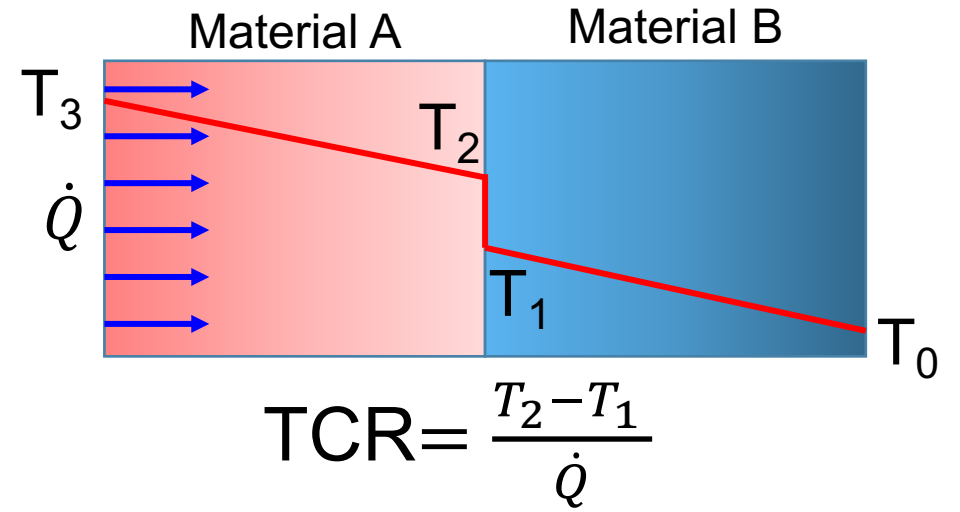
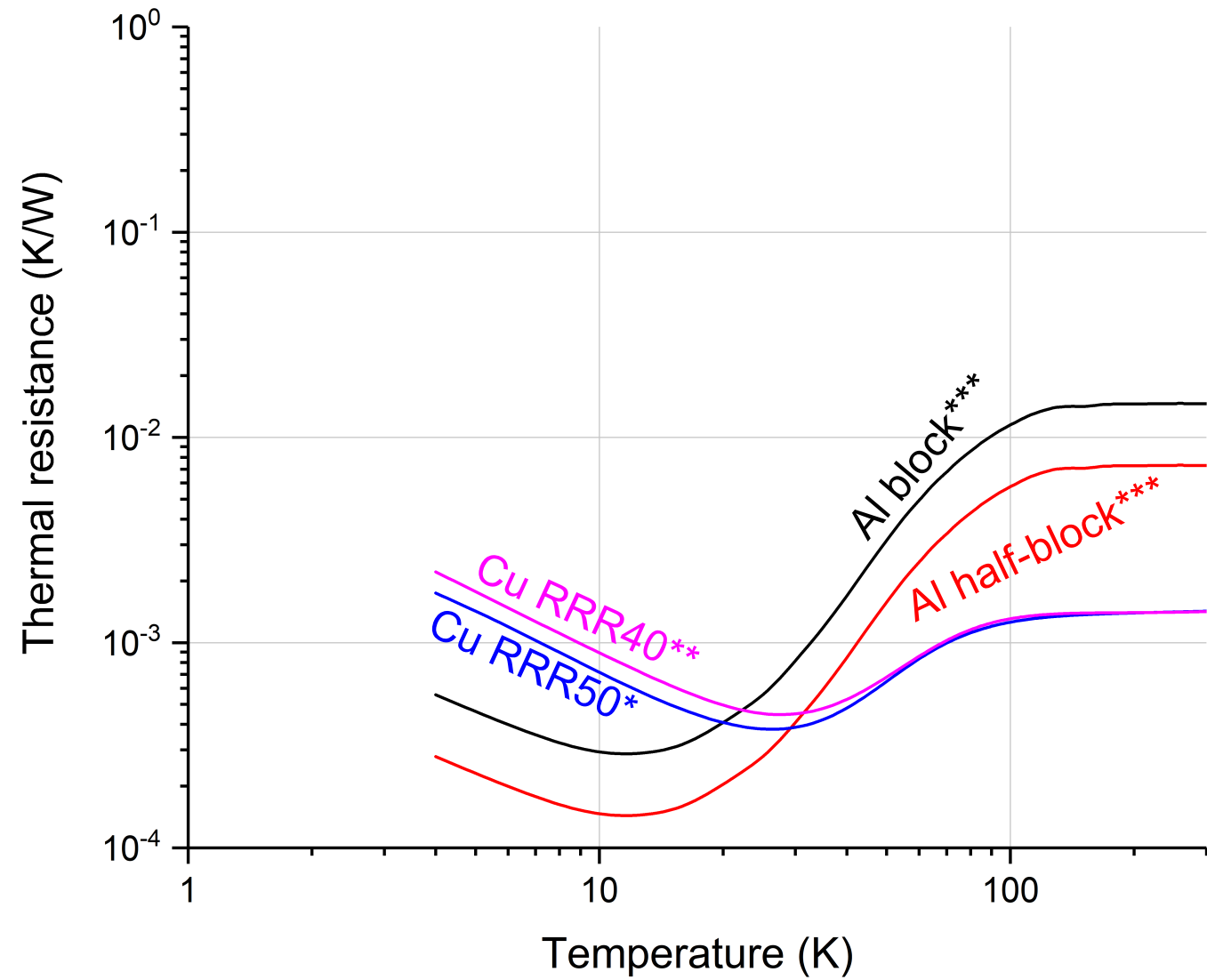
Measurement campaign – reproducibility

- For every measurement a new set of materials is used
- Every measurement is repeated twice (with new materials)
- The Cu and Al pieces are machined to $< 1 \mu\text{m}$ average roughness
 - Will be verified by a surface profiler
- Cu is washed in acetic acid (99.7% purity) to remove oxide layer*



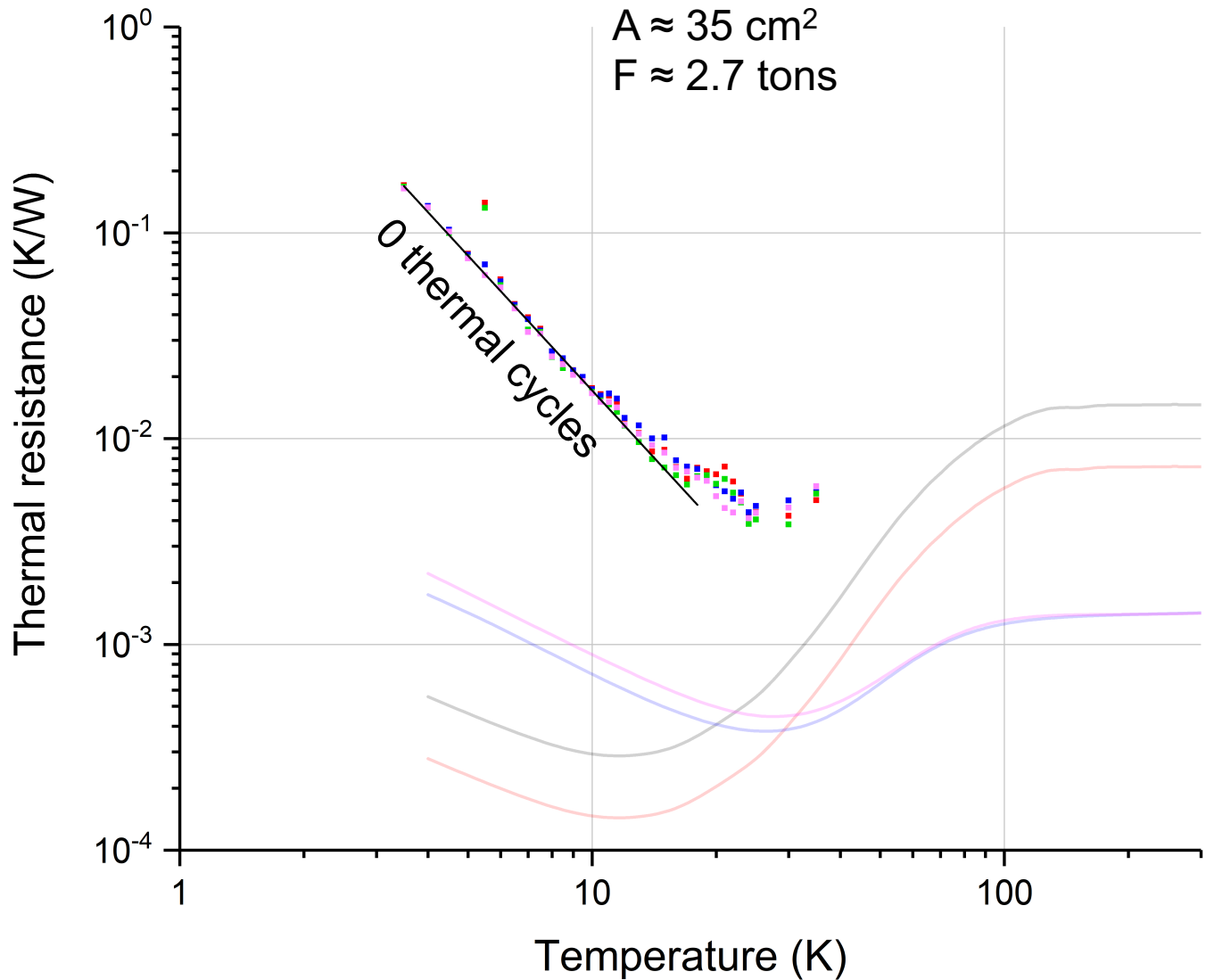
*K.L. Chavez, D. W. Hess, "A Novel Method of Etching Copper Oxide Using Acetic Acid", *Journal of The Electrochemical Society*, 148, 2001

Results — Base line



Results – Al – Cu dry contact

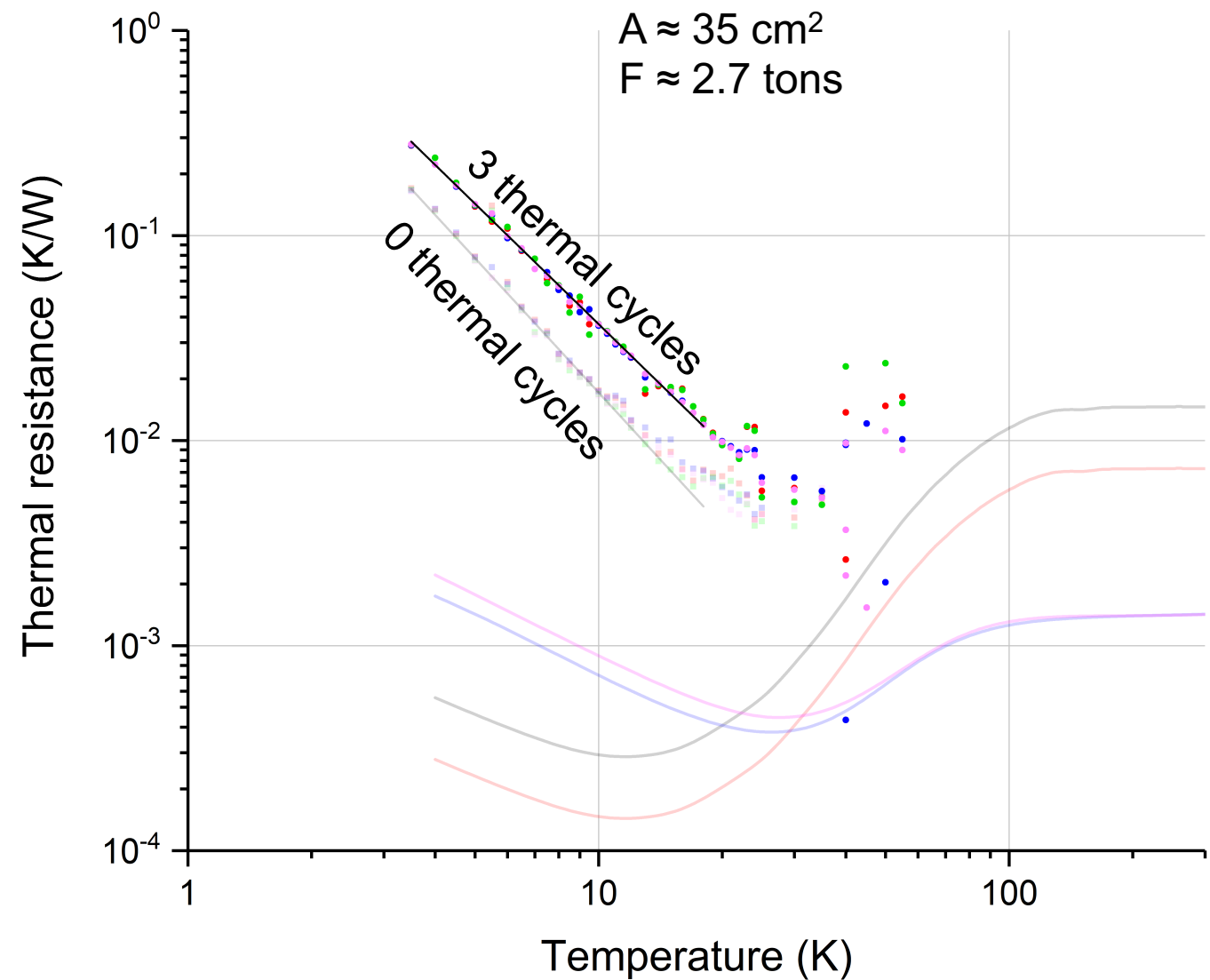
$A \approx 35 \text{ cm}^2$
 $F \approx 2.7 \text{ tons}$



$$\text{TCR}^{-1} = \alpha T^\gamma$$

Contact type	Thermal cycles	α	γ
Dry	0	0.39 ± 0.02	2.18 ± 0.04

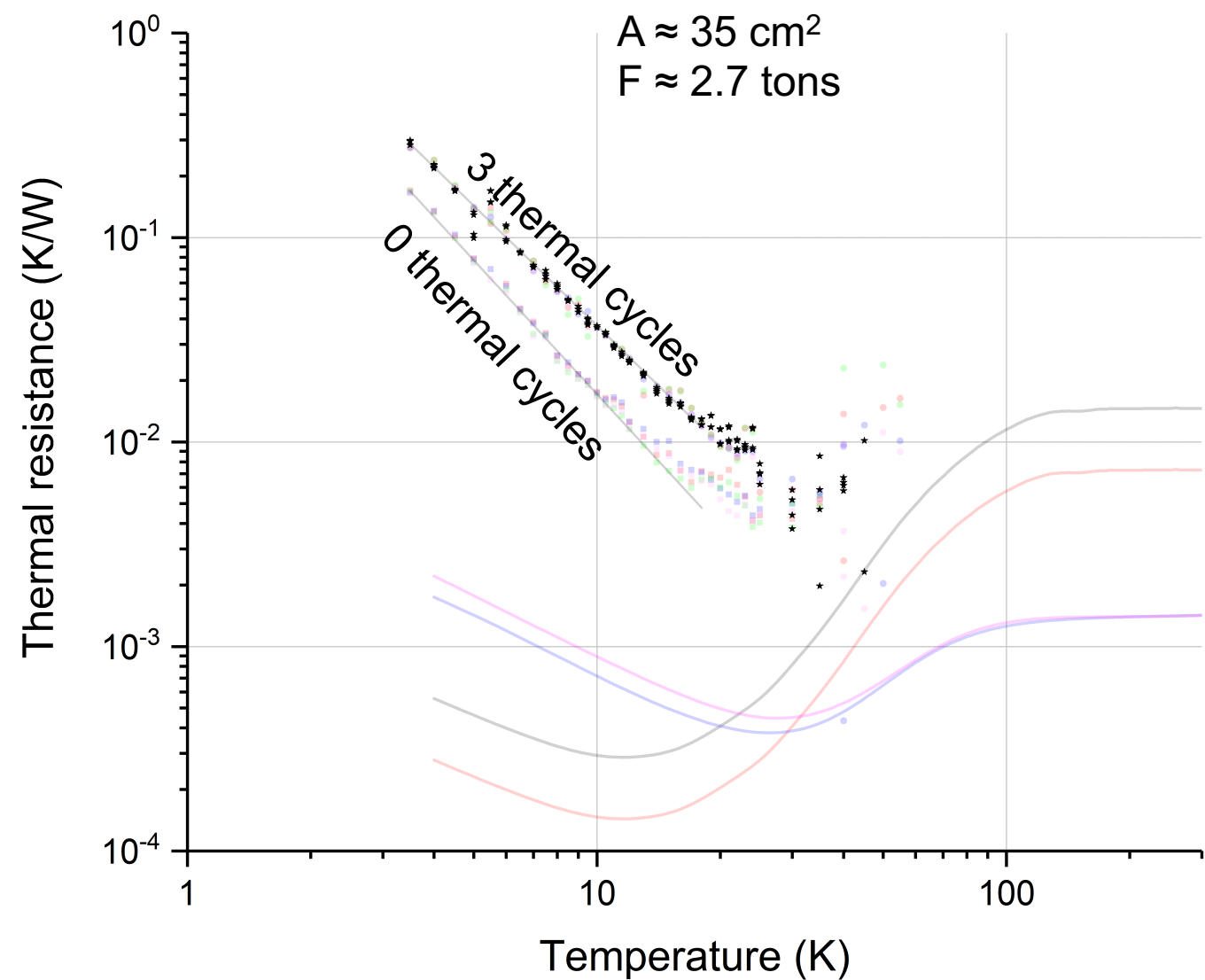
Results – Al – Cu dry contact after 3 thermal cycles with air contact



$$\text{TCR}^{-1} = \alpha T^{\gamma}$$

Contact type	Thermal cycles	α	γ
Dry	0	0.39 ± 0.02	2.18 ± 0.04
Dry	3 with air	0.30 ± 0.02	1.95 ± 0.04

Results – Al – Cu dry contact repeated measurement

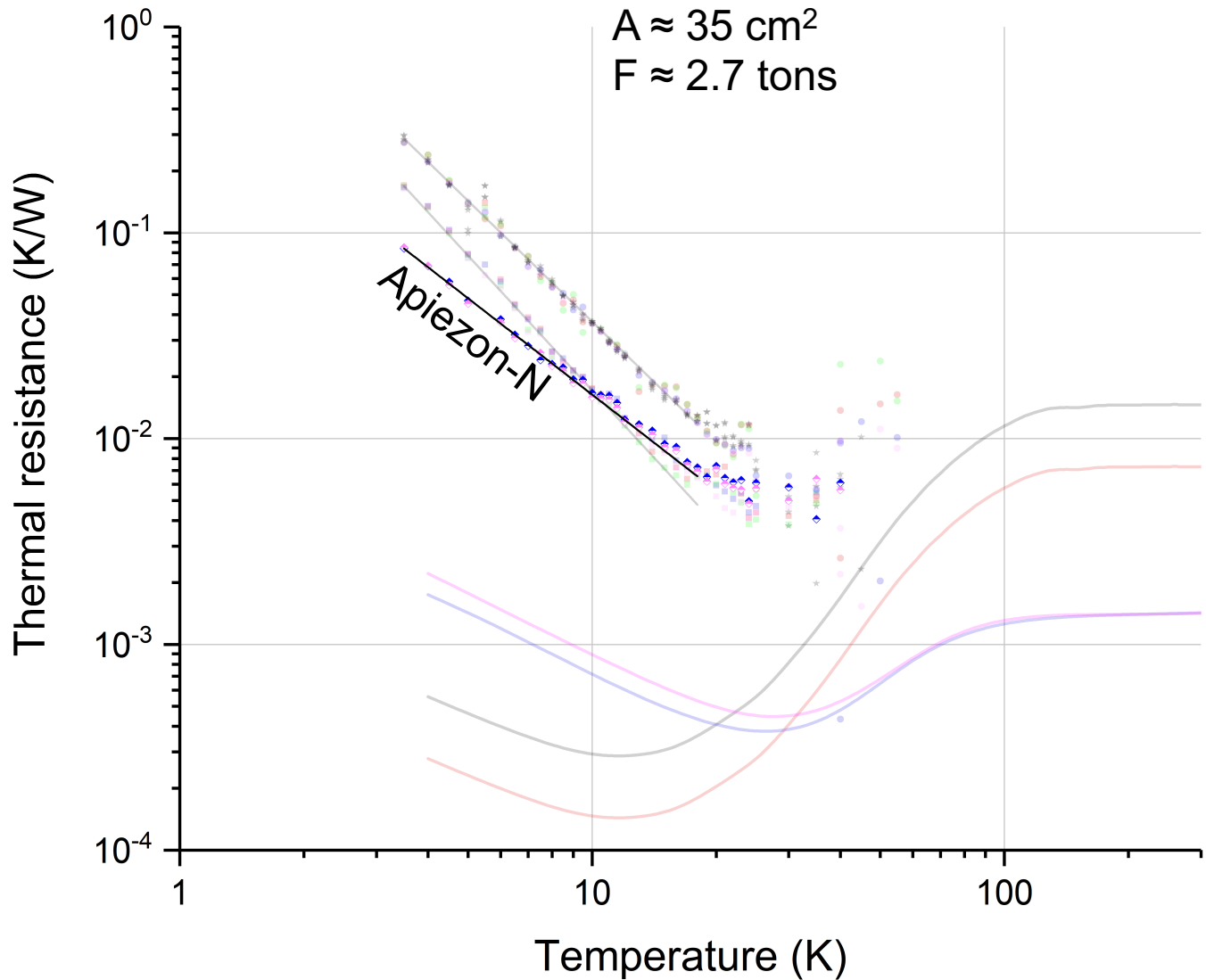


$$\text{TCR}^{-1} = \alpha T^{\gamma}$$

Contact type	Thermal cycles	α	γ
Dry	0	0.39 ± 0.02	2.18 ± 0.04
Dry	3 with air	0.30 ± 0.02	1.95 ± 0.04

Results – Al – Cu apiezon-N

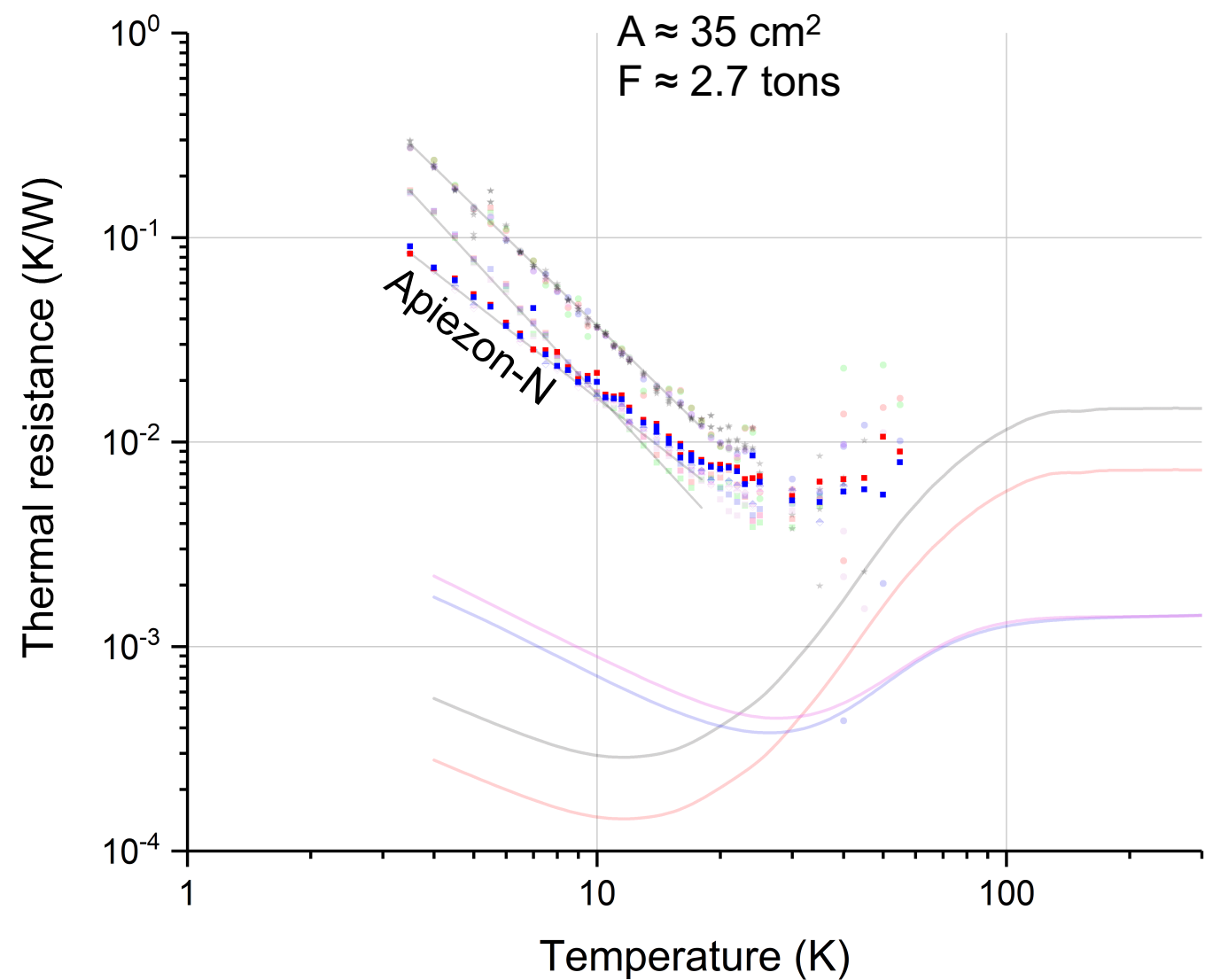
$A \approx 35 \text{ cm}^2$
 $F \approx 2.7 \text{ tons}$



$$\text{TCR}^{-1} = \alpha T^\gamma$$

Contact type	Thermal cycles	α	γ
Dry	0	0.39 ± 0.02	2.18 ± 0.04
Dry	3 with air	0.30 ± 0.02	1.95 ± 0.04
Apiezon-N	0	1.7 ± 0.2	1.55 ± 0.02

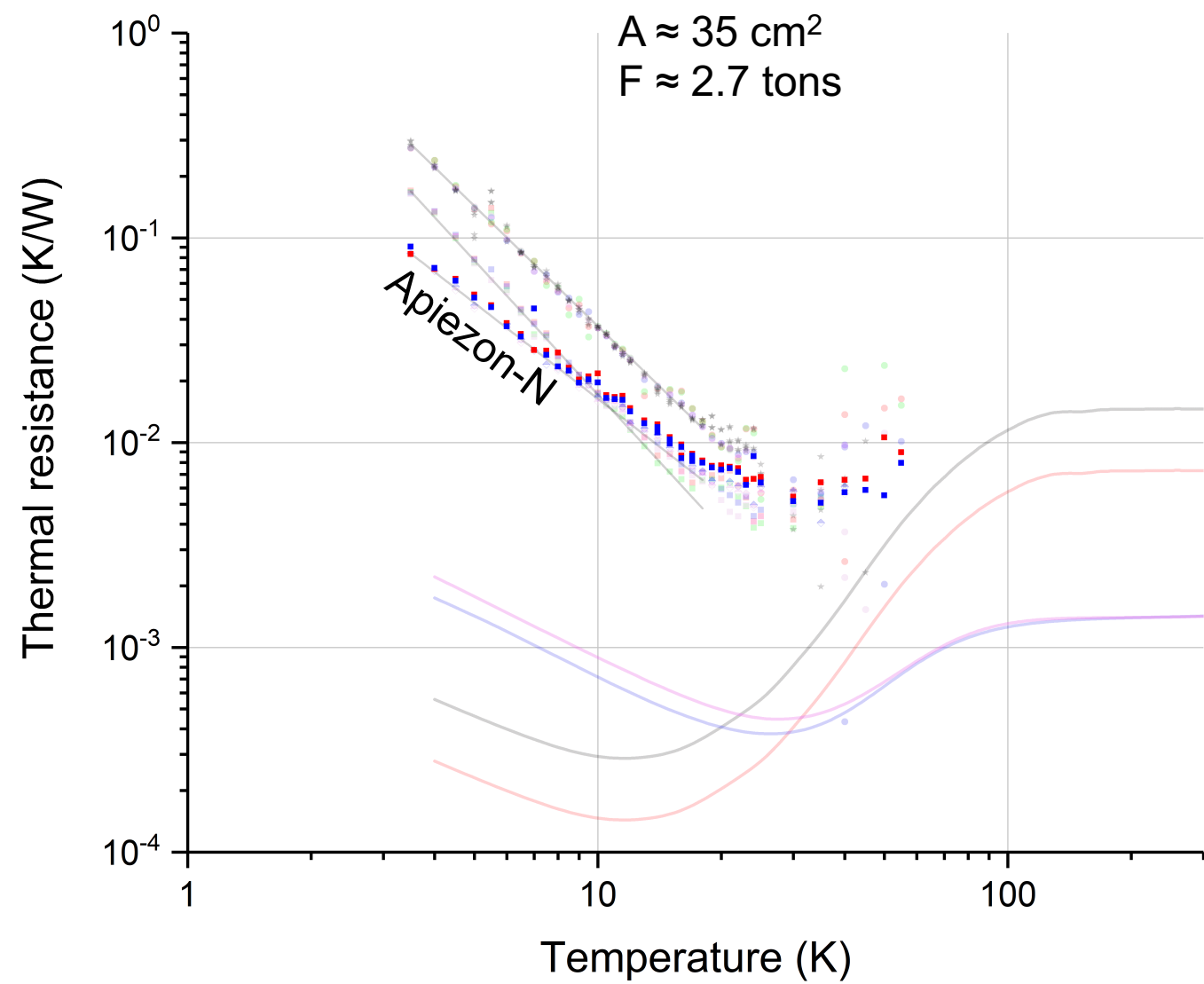
Results — Al – Cu apiezon after 1 thermal cycle



$$\text{TCR}^{-1} = \alpha T^{\gamma}$$

Contact type	Thermal cycles	α	γ
Dry	0	0.39 ± 0.02	2.18 ± 0.04
Dry	3 with air	0.30 ± 0.02	1.95 ± 0.04
Apiezon-N	0	1.7 ± 0.2	1.55 ± 0.02
Apiezon-N	1	2.0 ± 0.2	1.43 ± 0.02

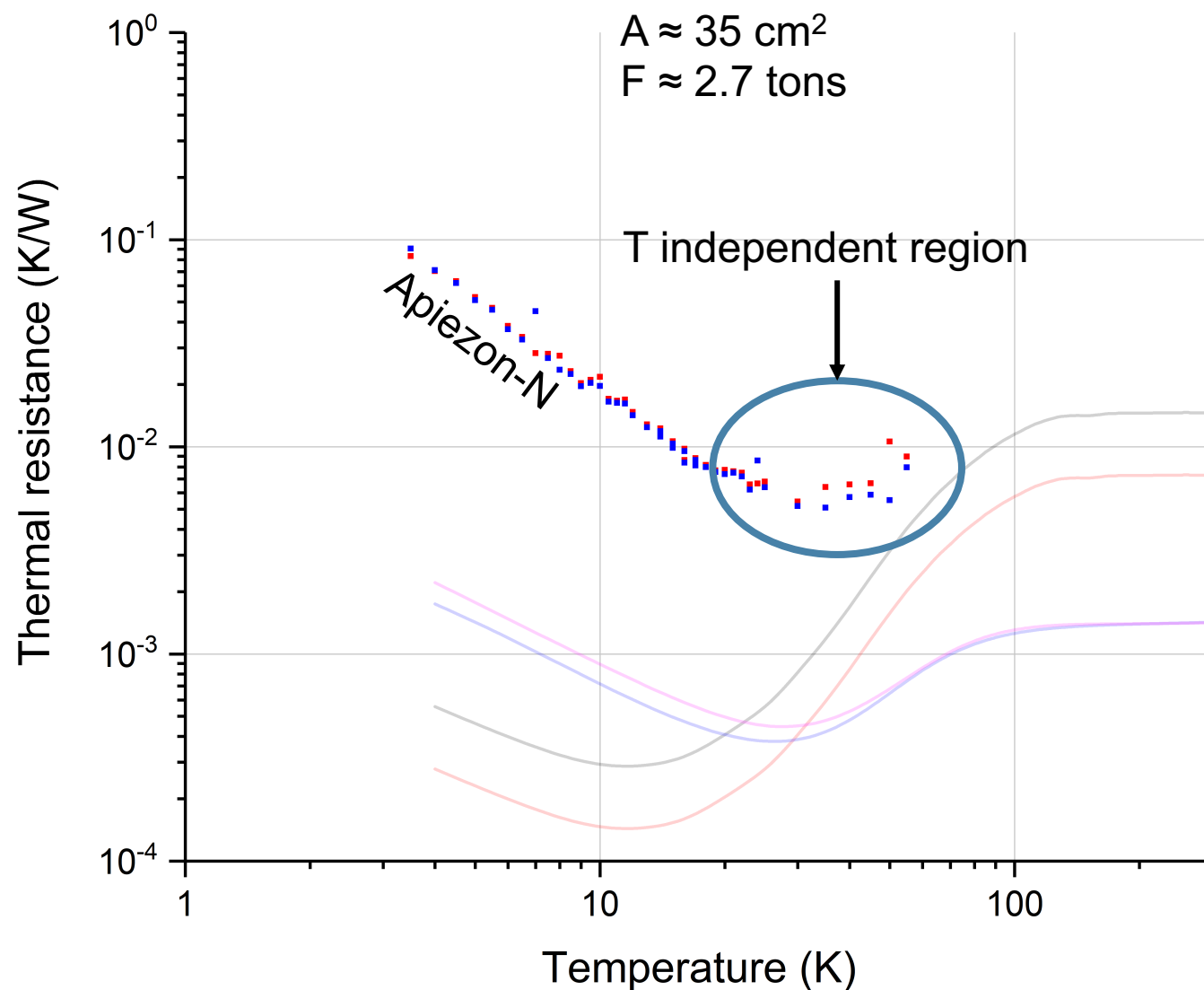
Results — Al – Cu apiezon after 1 thermal cycle



$$\text{TCR}^{-1} = \alpha T^{\gamma}$$

Contact type	Thermal cycles	α	γ
Dry	0	0.39 ± 0.02	2.18 ± 0.04
Dry	3 with air	0.30 ± 0.02	1.95 ± 0.04
Apiezon-N	0	1.7 ± 0.2	1.55 ± 0.02
Apiezon-N	1	2.0 ± 0.2	1.43 ± 0.02
Apiezon-N	1+1 with air	1.7 ± 0.2	1.54 ± 0.02

Results — Al – Cu TCR @ intermediate temperature



- 20 – 50 K range measured accurately after heater upgrade (3 W → 10 W)

Conclusions

- TCR is crucial for conduction cooled SC coils design at LHe temperatures
- The TCR between Cu RRR50 and Al RRR1600 was successfully measured
 - Dry contact
 - $\approx T^{-2}$ dependence was measured between 3.5 – 20 K
 - A degradation by a factor of 2 was observed after 3 thermal cycles and contact with air
 - Apiezon-N contact
 - $\approx T^{-1.5}$ dependence was measured between 3.5 – 20 K
 - No degradation was observed with 2 thermal cycles or air contact

Conclusions

- In the 20-60 K range, TCR seems to be temperature independent
- So far the lowest TCR at LHe temperature was obtained with Apiezon-N (≈ 70 mK/W)
- All these measurements will be done a second time to show reproducibility